



processor module M580 - Level 3 - Distributed

BMEP583020

Modicon M580

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Range of product

Product or component type	Processor module
Complementary	
Number of racks	8
Local I/O processor capacity (discrete)	3072 I/O
Local I/O processor capacity (analog)	768 I/O
Number of application specific channel (local rack)	108
Application specific I/O	Serial link Motion control HART SSI encoder Counter Accurate time stamping
Checks	Process control
Control channels	Programmable loops
Integrated connection type	1 Ethernet TCP/IP for service port 2 Ethernet TCP/IP for device network USB type mini B
Number of distributed equipment	128
Communication module processor capacity	8 AS-Interface module 3 Ethernet communication module
Communication service	DIO scanner
Memory description	Expandable flash, 4 GB for data storage Integrated RAM, 10 kB for system memory Integrated RAM, 12 MB for program Integrated RAM, 1024 kB for data
Application structure	periodic fast task auxiliary tasks 128 event tasks tyclic/periodic master task

Number of instructions per ms

Current consumption

MTBF reliability

15 Kinst/ms 65 % Boolean + 35 % fixed arithmetic

20 Kinst/ms 100 % Boolean

295 mA at 24 V DC

775000 H

Marking	CE
Environment	
Vibration resistance	3 gn
Shock resistance	30 gn
Ambient air temperature for operation	060 °C
Ambient air temperature for storage	-4085 °C
Operating altitude	02000 m 20005000 m with derating factor
Relative humidity	595 % at 55 °C without condensation
IP degree of protection	IP20
Directives	2014/35/EU - low voltage directive 2014/30/EU - electromagnetic compatibility
Product certifications	CE UL CSA RCM EAC Merchant Navy
Standards	EN 61131-2 EN/IEC 61010-2-201 UL 61010-2-201 CSA C22.2 No 61010-2-201 IACS E10 EN/IEC 61000-6-5, interface type 1 and type 2 EN/IEC 61850-3, location G
Environmental characteristic	Hazardous location class I division 2
Supply	Internal power supply via rack
Status LED	1 LED (green) processor running (RUN) 1 LED (red) processor or system fault (ERR) 1 LED (red) I/O module fault (I/O) 1 LED (green) download in progress (DL) 1 LED (red) memory card or CPU flash fault (BACKUP) 1 LED (green/red) ETH MS (Ethernet port configuration status) 1 LED (green/red) Eth NS (Ethernet network status)
Net weight	0.849 kg
Packing Units	
Unit Type of Package 1	PCE
Number of Units in Package 1	1
Package 1 Height	9.0 cm
Package 1 Width	17.8 cm
Package 1 Length	25.0 cm
Package 1 Weight	869.0 g
Unit Type of Package 2	S03
Number of Units in Package 2	6
Package 2 Height	30.0 cm
Package 2 Width	30.0 cm
Package 2 Length	40.0 cm
Package 2 Weight	5.65 kg
Offer Sustainability	
Sustainable offer status	Green Premium product

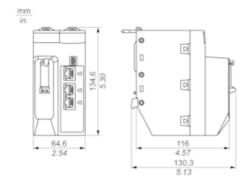
REACh Regulation	REACh Declaration
EU RoHS Directive	Pro-active compliance (Product out of EU RoHS legal scope) EU RoHS Declaration
Mercury free	Yes
China RoHS Regulation	China RoHS declaration
RoHS exemption information	Yes
Circularity Profile	End of Life Information
WEEE	The product must be disposed on European Union markets following specific waste collection and never end up in rubbish bins

Product datasheet

BMEP583020

Dimensions Drawings

CPU Module Only

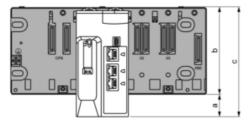


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Dimensions Drawings

Modules Mounted on Racks



a: additional space below the rack to accommodate the height of the CPU. For an X Bus rack, the value is 30.9 mm (1.217 in.); for an Ethernet rack, the value is 29.49 mm (1.161 in.).

b: the height of the rack. For an X Bus rack, the height is 103.7 mm (4.083 in.); for an Ethernet rack, the height is 105.11 mm (4.138 in.).

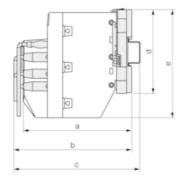
c: the height of the main local rack, 134.6 mm (5.299 in.)

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Dimensions Drawings

Modules and Cables Mounted in an Enclosure



a: enclosure depth: 135 mm (5.315 in.)

b: wiring + module depth: > 146 mm (5.748 in.)

c: wiring + module + DIN rail depth: > 156 mm (6.142 in.)

d: rack height: for an X Bus rack 103.7 mm (4.083 in.); for an Ethernet rack, 105.11 mm (4.138 in.)

e: module height: 134.6 mm (5.299 in.)

Recommended replacement(s)